Quad 2-Input Multiplexer

The LSTTL/MSI SN74LS157 is a high speed Quad 2-Input Multiplexer. Four bits of data from two sources can be selected using the common Select and Enable inputs. The four buffered outputs present the selected data in the true (non-inverted) form. The LS157 can also be used to generate any four of the 16 different functions of two variables. The LS157 is fabricated with the Schottky barrier diode process for high speed and is completely compatible with all ON Semiconductor TTL families.

- Schottky Process for High Speed
- Multifunction Capability
- Non-Inverting Outputs
- Input Clamp Diodes Limit High Speed Termination Effects
- Special Circuitry Ensures Glitch Free Multiplexing
- ESD > 3500 Volts

GUARANTEED OPERATING RANGES

Symbol	Parameter	Min	Тур	Max	Unit
V _{CC}	Supply Voltage	4.75	5.0	5.25	V
T _A	Operating Ambient Temperature Range	0	25	70	°C
I _{OH}	Output Current – High			-0.4	mA
I _{OL}	Output Current – Low			8.0	mA



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LOW POWER SCHOTTKY



PLASTIC N SUFFIX CASE 648



SOIC D SUFFIX CASE 751B

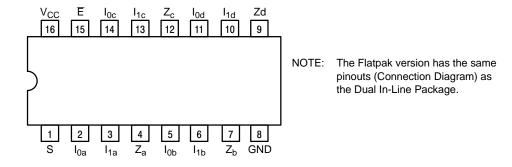


SOEIAJ M SUFFIX CASE 966

ORDERING INFORMATION

Device	Package	Shipping	
SN74LS157N	16 Pin DIP	2000 Units/Box	
SN74LS157D	SOIC-16	38 Units/Rail	
SN74LS157DR2	SOIC-16	2500/Tape & Reel	
SN74LS157M	SOEIAJ-16	See Note 1	
SN74LS157MEL	SOEIAJ-16	See Note 1	

 For ordering information on the EIAJ version of the SOIC package, please contact your local ON Semiconductor representative.



		LOADING (Note a)	
PIN NAMES		HIGH	LOW
S E $I_{0a} - I_{0d}$ $I_{1a} - I_{1d}$ $Z_a - Z_d$	Common Select Input Enable (Active LOW) Input Data Inputs from Source 0 Data Inputs from Source 1 Multiplexer Outputs	1.0 U.L. 1.0 U.L. 0.5 U.L. 0.5 U.L. 10 U.L.	0.5 U.L. 0.5 U.L. 0.25 U.L. 0.25 U.L. 5 U.L.

NOTES: a) 1 TTL Unit Load (U.L.) = 40 μ A HIGH/1.6 mA LOW.

Figure 1. Connection Diagram DIP (TOP VIEW)

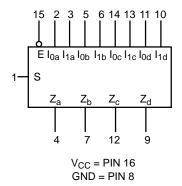


Figure 2. Logic Symbol

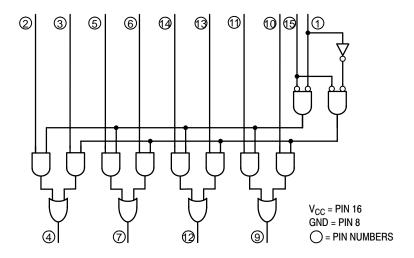


Figure 3. Logic Diagram

FUNCTIONAL DESCRIPTION

The LS157 is a Quad 2-Input Multiplexer fabricated with the Schottky barrier diode process for high speed. It selects four bits of data from two sources under the control of a common Select Input (S). The Enable Input (\overline{E}) is active LOW. When \overline{E} is HIGH, all of the outputs (Z) are forced LOW regardless of all other inputs.

The LS157 is the logic implementation of a 4-pole, 2-position switch where the position of the switch is determined by the logic levels supplied to the Select Input. The logic equations for the outputs are:

$$Z_{a} = \overline{E} \cdot (I_{1a} \cdot S + I_{0a} \cdot \overline{S}) \qquad Z_{b} = \overline{E} \cdot (I_{1b} \cdot S + I_{0b} \cdot \overline{S})$$

$$Z_{c} = \overline{E} \cdot (I_{1c} \cdot S + I_{0c} \cdot \overline{S}) \qquad Z_{d} = \overline{E} \cdot (I_{1d} \cdot S + I_{0d} \cdot \overline{S})$$

$$Z_c = \overline{E} \cdot (I_{1c} \cdot S + I_{0c} \cdot \overline{S})$$
 $Z_d = \overline{E} \cdot (I_{1d} \cdot S + I_{0d} \cdot \overline{S})$

A common use of the LS157 is the moving of data from two groups of registers to four common output busses. The particular register from which the data comes is determined by the state of the Select Input. A less obvious use is as a function generator. The LS157 can generate any four of the 16 different functions of two variables with one variable common. This is useful for implementing highly irregular logic.

TRUTH TABLE

ENABLE	SELECT INPUT	INP	UTS	OUTPUT
Ē	S	I ₀	I ₁	Z
Н	Х	Х	Х	L
L	Н	Х	L	L
L	Н	Х	Н	Н
L	L	L	Χ	L
L	L	Н	Χ	Н

H = HIGH Voltage Level

L = LOW Voltage Level

X = Don't Care

DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

		Limits					
Symbol	Parameter	Min	Тур	Max	Unit	Tes	t Conditions
V _{IH}	Input HIGH Voltage	2.0			V	Guaranteed Input HIGH Voltage for All Inputs	
V _{IL}	Input LOW Voltage			0.8	V	Guaranteed Input LOW Voltage for All Inputs	
V _{IK}	Input Clamp Diode Voltage		-0.65	-1.5	V	V _{CC} = MIN, I _{IN} =	–18 mA
V _{OH}	Output HIGH Voltage	2.7	3.5		V	V_{CC} = MIN, I_{OH} = MAX, V_{IN} = V_{IH} or V_{IL} per Truth Table	
.,	0		0.25	0.4	V	I _{OL} = 4.0 mA	$V_{CC} = V_{CC} MIN,$
V_{OL}	Output LOW Voltage		0.35	0.5	V	I _{OL} = 8.0 mA	V _{IN} = V _{IL} or V _{IH} per Truth Table
l _{ін}	Input HIGH Current I ₀ , I ₁ E, S			20 40	μΑ	V _{CC} = MAX, V _{IN} = 2.7 V	
	I ₀ , I ₁ E, S			0.1 0.2	mA	V _{CC} = MAX, V _{IN} = 7.0 V	
I _{IL}	Input LOW Current I ₀ , I ₁ E, S			-0.4 -0.8	mA	V _{CC} = MAX, V _{IN} = 0.4 V	
Ios	Short Circuit Current (Note 2)	-20		-100	mA	V _{CC} = MAX	
I _{CC}	Power Supply Current			16	mA	V _{CC} = MAX	

^{2.} Not more than one output should be shorted at a time, nor for more than 1 second.

AC CHARACTERISTICS $(T_A = 25^{\circ}C)$

		Limits					
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions	
t _{PLH} t _{PHL}	Propagation Delay Data to Output		9.0 9.0	14 14	ns	Figure 2	
t _{PLH} t _{PHL}	Propagation Delay Enable to Output		13 14	20 21	ns	Figure 1	$V_{CC} = 5.0 \text{ V}$ $C_L = 15 \text{ pF}$
t _{PLH} t _{PHL}	Propagation Delay Select to Output		15 18	23 27	ns	Figure 2	

AC WAVEFORMS

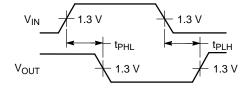


Figure 1.

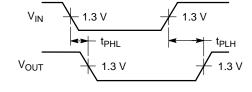
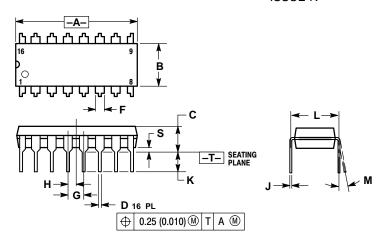


Figure 2.

PACKAGE DIMENSIONS

N SUFFIX PLASTIC PACKAGE CASE 648-08 ISSUE R

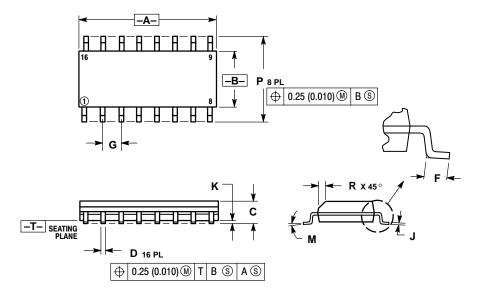


- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 5. ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100	BSC	2.54 BSC		
Н	0.050	BSC	1.27 BSC		
J	0.008	0.015	0.21	0.38	
K	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
М	0°	10°	0°	10 °	
S	0.020	0.040	0.51	1.01	

PACKAGE DIMENSIONS

D SUFFIX PLASTIC SOIC PACKAGE CASE 751B-05 **ISSUE J**



NOTES:

- NOTES:

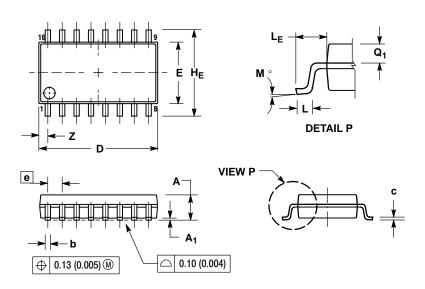
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
 5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	9.80	10.00	0.386	0.393	
В	3.80	4.00	0.150	0.157	
С	1.35	1.75	0.054	0.068	
D	0.35	0.35 0.49		0.019	
F	0.40	1.25	0.016	0.049	
G	1.27	BSC	0.050 BSC		
J	0.19	0.25	0.008	0.009	
K	0.10	0.25	0.004	0.009	
M	0°	7°	0°	7°	
P	5.80	6.20	0.229	0.244	
R	0.25	0.50	0.010	0.019	

PACKAGE DIMENSIONS

M SUFFIX

SOEIAJ PACKAGE CASE 966-01 **ISSUE O**



- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: MILLIMETER.

 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.

 4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.

 5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AND ADMINISTRATION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM PACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α		2.05		0.081
A ₁	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
С	0.18	0.27	0.007	0.011
D	9.90	10.50	0.390	0.413
E	5.10	5.45	0.201	0.215
е	1.27	BSC	0.050 BSC	
HE	7.40	8.20	0.291	0.323
L	0.50	0.85	0.020	0.033
LE	1.10	1.50	0.043	0.059
M	0 °	10 °	0 °	10°
Q ₁	0.70	0.90	0.028	0.035
Z		0.78		0.031

SN741 S157

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